



Design of Low Power Flip-Flop Using Topological Compression Technique

Sudha.H¹, Sahana Uppin²

Associate Professor, Dept. of ECE, BIT College, Bangalore, Karnataka, India¹

PG Student [VLSI and Embedded System], Dept. of ECE, BIT College, Bangalore, Karnataka, India²

ABSTRACT: As transistor dimensions continues to shrink and increase market trends, extremely required minimized power consumption in modern circuits. In integrated circuit, generally more than half of power is dissipated in random logic, of which half of the power is dissipated by flip-flop. In proposed system mainly focused on power saving and design with less transistor count. The topological compression technique is applied to achieve power reduction such that merging of logically equivalent transistor to an unconventional latches structure. The transistor count is reduced because only three, connected to clock signal which reduce the power consumption and smaller sum of transistor count assures less chip area as compare conventional flip-flop. The sleep transistor with TCFF helps to reduce power further. The proposed system is designed and implementation had been carried out with 32nm CMOS technology shows almost all conventional flip-flop are replaced with proposed flip-flop.

KEYWORDS: low power, TCFF, sleep transistor.

I.INTRODUCTION

The market trend keeps on expanding day by day which has demanded for reduction power in portable device. For example mobile phone, digitals camera, tablet PC, development with various advance features and technology. For such battery-working equipment require small amount of power. In all type of portable electronic design requirement is reduction in weight and size of device which is concentrated by the number of power source used and their lifetime. In addition to fulfil the requirement with advance technology goes for tumbling the transistor size, reducing supply voltage, more complexity chip design which give rise to larger amount of power dissipation. Therefore due to this all reason there has been increased demand for need of CMOS low-power design. The memory device application has been widespread in a market which needs low consuming power.

As the result Large Scale Integration comes on light as it is the place which to be take apart. In Large Scale Integrate, the main component is flip-flops but the drawback is it consume more amount of power therefore we reduce power consume by removing precharge circuit. In proposed system main goal is power reduction, decrease transistor count and maintain high performances. Therefore use topologically compression flip-flop and topologically compression flip-flop with sleep transistor to achieve power saving without degradation timing performances and cell area. The topological compression technique is applied to flip-flop which result in topological-compression flip-flop (TCFF). This as low power as compare to conventional flip-flop.TCFF is made up of transistor merging and which reduce power but maintain performance and cell area. The topological-compression flip-flop as lesser transistor count as compare to other flip-flop because it uses only three clock fed transistor thus result lower power dissipation operation. It removes additional power wastage in circuit as it does not consist of dynamic and pre-charged circuit.

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II. LITERATURE SURVEY

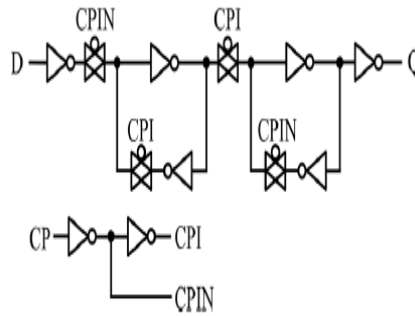


Fig 1 Conventional transmission-gate flip-flop

Literature survey gives brief idea of on analyse of typical low-power flip-flop and limitation as compare to conventional flip-flop shown in fig 1

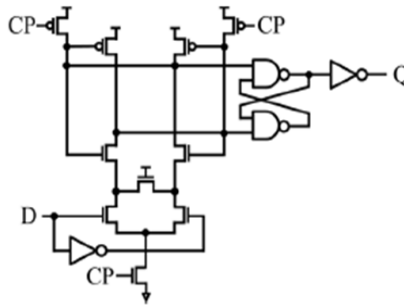


Fig 2: Differential sense-amplifier flip-flop (DiffFF).

Fig 2 shows differential sense-amplifier, it is used to amplify a small voltage difference between signals. It is widely used in semiconductor memory device, in order to read the data stored in memory cell, decode the read out data and amplify the data which is being read out. This type of flip-flop as pre-charge operation in every clock-low state hence the condition of lower data activity goes down with reduction power. A extra bias circuit and customized clock generator is required if use reduced clock swing which result in more power dissipation.

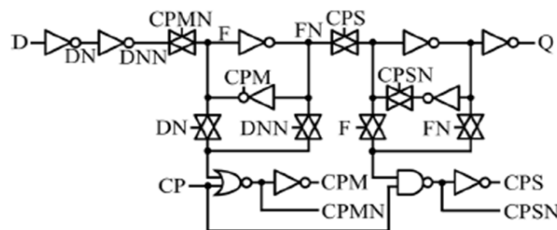


Fig 3: Conditional-clocking flip-flop

Fig 3 shows Conditional-clocking flip-flop, used to reduce system power by controlling internal node in the pre-charge operation. This type of flip-flop mainly used to achieve from functional point of view. Therefore this circuit is used to monitor input data change in each clock cycle and control the behaviour. By using this circuit power is reduced because power is not dissipated when input remain unchanged. But cell area increase almost doubles that of the conventional flip-flop.

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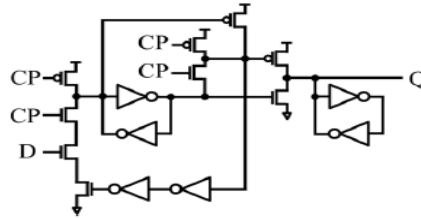


Fig 4 cross-charge flip-flop

Fig 4 shows cross-charge control flip-flop, it has two dynamic nodes, where first node is connected to the gate of output transistor through an inverter circuit and second node is directly connected to the output transistor. It is used drive output transistor separately in order to charging and discharging of gate capacitance. During actual operation, when data is high, some of internal nodes are pre-set with clock signal which result in extra power dissipation to charge and discharge internal nodes. The problem associate with circuit is pre-set operation.

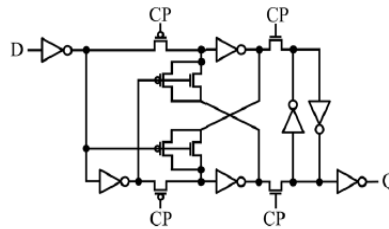


Fig 5 Adaptive-coupling type flip-flop

Fig 5 shows adaptive-coupling type flip-flop, it consist six transistor memory cells and single-channel transmission gate with additional dynamic circuit is used for a data line in order to reduce clock related transistor count. The single channel transmission gate and dynamic circuit are affect by process variation thus, their optimization is difficult and performance degradation

III.PROPOSED SYSTEM

In proposed system, in order to reduce power dissipation of the flip-flop and keeping competitive performance and same cell area, we tried to reduce transistor count those operating with clock signals.

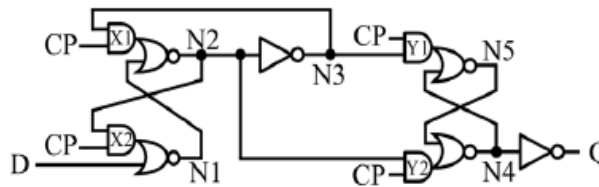


Fig 6 Schematic of proposed flip-flop

The conventional flip-flop consists of 12 clock-related transistors. To reduce clock-related transistor directly from circuit is quite too difficult because transmission gate required 2-phase clock signal and it should construct using both PMOS and NMOS. Therefore in proposed system replace transmission gate with combinational circuit show in fig 6.

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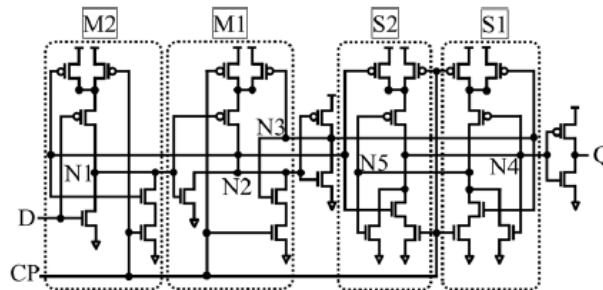


Fig 7 Transistor level of proposed flip-flop

The proposed system transistor level flip-flop is shown in fig 7, to reduce transistor count based on logical equivalence, we consider a method that consists of two steps. First step, the circuit with two or more logically equivalent AND or OR logic parts which have the same input signal combination, including especially input signal as clock signal. Second step, merge those parts in transistor level. The merging process to original circuit results as shown in fig 8, which consists of less than seven transistors as compared to the original circuit and three clock-related transistors. There is no additional power dissipation because no dynamic circuit and pre-charge circuit.

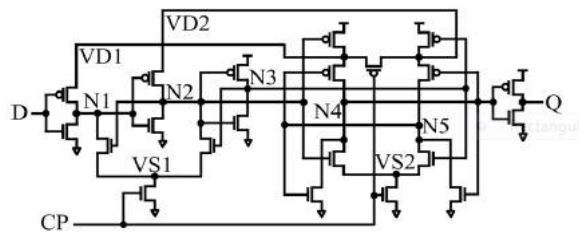


Fig 8 Topologically compressed flip-flop

This circuit consists of two different types of latches in the master and slave. The main feature of this circuit is that it operates in a single phase and it has two sets of logically equivalent inputs. The master-latch is an asymmetrical single data input and the slave-latch is known as a rest-set type. When CP is low, the PMOS connected to transistor CP turns ON and NMOS turns OFF, the master latch is in input mode. Both voltage supplies (VD1 and VD2) are pulled up to power supply level and input data is stored in the master latch. When CP is high, the PMOS transistor connected to CP turns OFF and NMOS turns ON and the slave latch becomes data output mode. In this condition, data stored in the master latch is transferred to the slave latch and then to output Q.

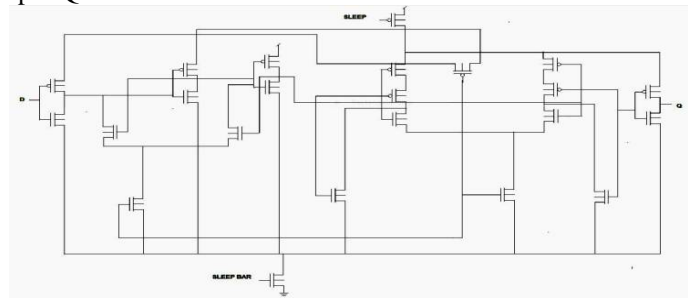


Fig 9 Topologically compressed flip-flop with sleep transistor

The fig 9 shows a topologically compressed flip-flop with a sleeping transistor. When transistors are not required during operation, they are turned off. When V_t is high, the sleep transistor is between the supply voltage and the pull-up network, and

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between pull down network and ground for high switching speed, when it is low transistor are used in circuit. Efficient power management is done by sleep control mechanism.

IV. EXPERIMENTAL RESULT

The schematic and simulation result of proposed system

1. Topologically compressed flip-flop

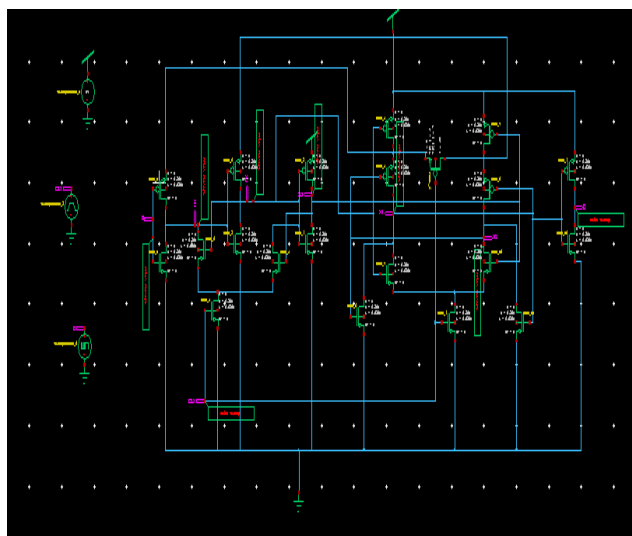


Fig 10: Schematic result

The fig 10 show schematic design of Topologically compressed flip-flop using tanner tool.

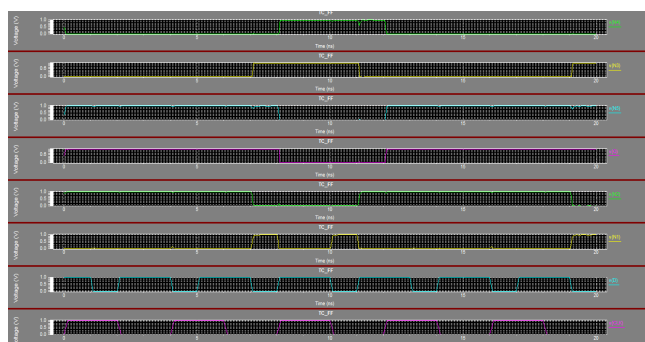


Fig 11: Simulation result

The fig 11 show simulation result of above schematic.

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Power Results
Vdd end from time 0 to 2e-008
Average power consumed -> 6.276990e-006 watts
Max power 2.587745e-004 at time 1.11e-008
Min power 2.643478e-007 at time 1.14562e-010

- END NON-GRAPHICAL DATA
-
- Parsing                      0.01 seconds
- Setup                        0.01 seconds
- DC operating point           0.06 seconds
- Transient Analysis           0.25 seconds
- Overhead                     2.00 seconds
- -----
- Total                        2.33 seconds
- Simulation completed
- End of T-Spice output file
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Fig 12: Power analysis

The fig 12 show power analysis, which consist of power consume of proposed system

2. Topologically compressed flip-flop with sleep transistor

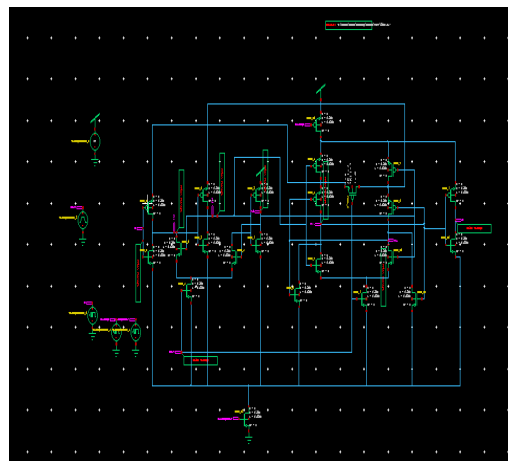


Fig 13: Schematic result

The fig 13 show schematic design of topologically compressed flip using sleep transistor. The design contains less power consumption than TCFF.

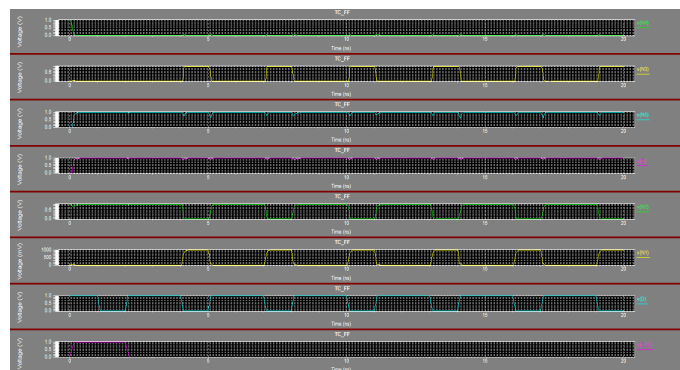


Fig 14 : Simulation result

The fig 14 show simulation result of above schematic.



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Power Results
vdd gnd from time 0 to 2e-008
Average power consumed -> 8.153289e-006 watts
Max power 1.562074e-004 at time 4.1e-009
Min power 1.173194e-007 at time 1.14811e-008

* END NON-GRAPHICAL DATA
*
* Parsing                0.01 seconds
* Setup                  0.01 seconds
* DC operating point     0.17 seconds
* Transient Analysis     0.29 seconds
* Overhead               2.25 seconds
* -----
* Total                  2.73 seconds
*
* Simulation completed
* End of T-Spice output file

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Fig 15: power analysis

The fig 15 show power analysis, which consist of power consume of proposed system

TYPE OF FLIP-FLOP	TECHNOLOGY	NO. OF TRANSISTOR	MAXIMUM POWER
TGFF	45nm	28	8.15458e-003
DFF	45nm	26	1.38715e-002
XCFE	45nm	24	9.51515e-003
ACFF	45nm	24	8.6340e-003
TCFF	45nm	21	7.4841e-004
TCFF	32nm	21	2.58774e-004
TCFF WITH SLEEP TRANSISTOR	32nm	23	1.56207e-004

Table 1: Power comparison between flip-flops

This table show power consumption of different flip-flops. By this table it show that power dissipated by proposed system is less as compare to pervious system

V. CONCLUSION

An extremely low-power flip-flop, TCFF is proposed with topological compression design methodology. TCFF has the lowest power dissipation in almost all range of the data activity as compared with other low-power flip-flop. the power dissipation through TCFF is less than compare with pervious technique used. TCFF with sleep transistor, power dissipation is lesser than that of TCFF. Hence by proposed system we achieved low power

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